

BFT25A NPN 5 GHz wideband transistor Rev. 5 — 12 September 2011

**Product data sheet** 

# 1. Product profile

## 1.1 General description

The BFT25A is a silicon NPN transistor, primarily intended for use in RF low power amplifiers, such as pocket telephones and paging systems with signal frequencies up to 2 GHz.

The transistor is encapsulated in a 3-pin plastic SOT23 envelope.

## **1.2 Features and benefits**

- Low current consumption (100 μA to 1 mA)
- Low noise figure
- Gold metallization ensures excellent reliability.

## 1.3 Quick reference data

#### Table 1.Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	-	8	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	5	V
I <sub>C</sub>	DC collector current		-	-	6.5	mA
P <sub>tot</sub>	total power dissipation	up to $T_s = 165 \ ^\circ C$	<u>[1]</u> _	-	32	mW
h <sub>FE</sub>	DC current gain	$I_C$ = 0.5 mA; $V_{CE}$ = 1 V	50	80	200	
f <sub>T</sub>	transition frequency	$    I_{C} = 1 \text{ mA}; V_{CE} = 1 \text{ V};     T_{amb} = 25 \text{ °C};     f = 500 \text{ MHz} $	3.5	5	-	GHz
G <sub>UM</sub>	maximum unilateral power gain	$I_{C}$ = 0.5 mA; V <sub>CE</sub> = 1 V; T <sub>amb</sub> = 25 °C; f = 1 GHz	-	15	-	dB
F	noise figure	$\label{eq:gamma} \begin{split} \Gamma &= \Gamma_{opt}; \ I_C = 0.5 \ \text{mA}; \\ V_{CE} &= 1 \ \text{V}; \\ T_{amb} &= 25 \ ^{\circ}\text{C}; \ \text{f} = 1 \ \text{GHz} \end{split}$	-	1.8	-	dB
		$\label{eq:constraint} \begin{split} & \Gamma = \Gamma_{opt}; \ I_C = 1 \ \text{mA}; \\ & V_{CE} = 1 \ \text{V}; \\ & T_{amb} = 25 \ ^{\circ}\text{C}; \ \text{f} = 1 \ \text{GHz} \end{split}$	-	2	-	dB

[1]  $T_s$  is the temperature at the soldering point of the collector tab.



# 2. Pinning information

Table 2.	Discrete pinning		
Pin	Description	Simplified outline	Symbol
Code: V1	10		
1	base		3
2	emitter		1-
3	collector	1 2	13
			2
			sym021

# 3. Ordering information

Table 3. Orde	ering infor	mation	
Type number	Package		
	Name	Description	Version
BFT25A	-	plastic surface mounted package; 3 leads	SOT23

## 4. Marking

Table 4. Marking	
Type number	Marking code <sup>[1]</sup>
BFT25A	34*

 $[1] \quad \ \ *=p: Made in Hong Kong.$ 

- \* = t : Made in Malaysia.
- \* = W : Made in China.

# 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	8	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	5	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	2	V
I <sub>C</sub>	DC collector current		-	6.5	mA
P <sub>tot</sub>	total power dissipation	up to $T_s = 165 \ ^\circ C$	<u>[1]</u> _	32	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	175	°C

[1]  $T_s$  is the temperature at the soldering point of the collector tab.

# 6. Thermal characteristics

Table 6.	Thermal characteristics				
Symbol	Parameter	Conditions	Тур	Unit	
R <sub>th(j-s)</sub>	from junction to soldering point		<u>[1]</u> 260	K/W	

[1]  $T_s$  is the temperature at the soldering point of the collector tab.

# 7. Characteristics

#### Table 7. Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub>	collector cut-off current	$I_{E} = 0 \text{ A}; V_{CB} = 5 \text{ V}$	-	-	50	nA
h <sub>FE</sub>	DC current gain	$I_{C}$ = 0.5 mA; $V_{CE}$ = 1 V	50	80	200	
f <sub>T</sub>	transition frequency	$I_{C} = 1 \text{ mA}; V_{CE} = 1 \text{ V};$ $T_{amb} = 25 \text{ °C};$ f = 500 MHz	3.5	5	-	GHz
C <sub>re</sub>	feedback capacitance	$\label{eq:lc} \begin{split} I_C &= i_c = 0 \text{ A};  \text{V}_{CB} = 1 \text{ V}; \\ f &= 1  \text{MHz} \end{split}$	-	0.3	0.45	pF
G <sub>UM</sub>	maximum unilateral power gain	$I_{C} = 0.5 \text{ mA}; V_{CE} = 1 \text{ V};$ $T_{amb} = 25 \text{ °C}; f = 1 \text{ GHz}$	<u>[1]</u> -	15	-	dB
F	noise figure	$\label{eq:constraint} \begin{split} & \Gamma = \Gamma_{opt}; \ I_C = 0.5 \ \text{mA}; \\ & V_{CE} = 1 \ \text{V}; \\ & T_{amb} = 25 \ ^{\circ}\text{C}; \ \text{f} = 1 \ \text{GHz} \end{split}$	-	1.8	-	dB
		$ \begin{split} &\Gamma = \Gamma_{opt}; \ I_C = 1 \ mA; \\ &V_{CE} = 1 \ V; \\ &T_{amb} = 25 \ ^{\circ}C; \ f = 1 \ GHz \end{split} $	-	2	-	dB

[1]  $G_{UM}$  is the maximum unilateral power gain, assuming  $S_{12}$  is zero and

$$G_{\rm UM} = 10 \log \frac{|S_{21}|^2}{(I - |S_{11}|^2)(I - |S_{22}|^2)} dB$$

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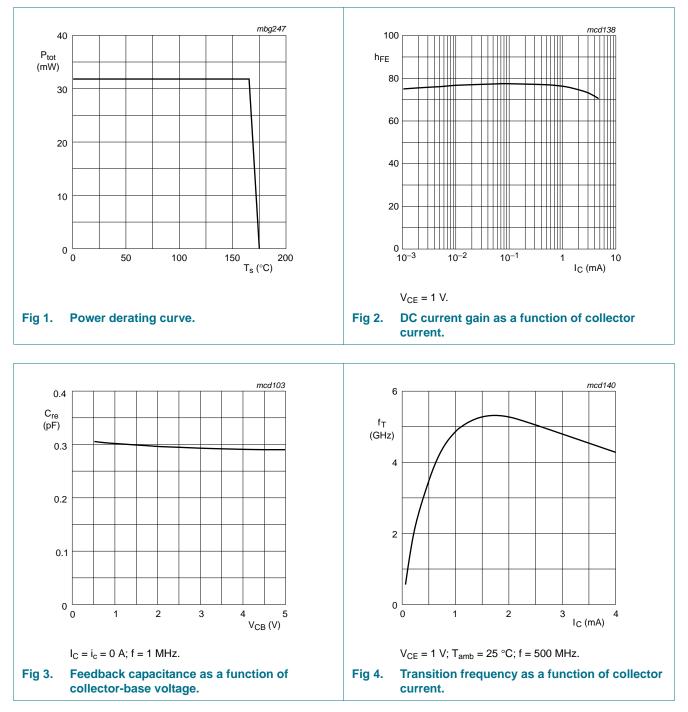
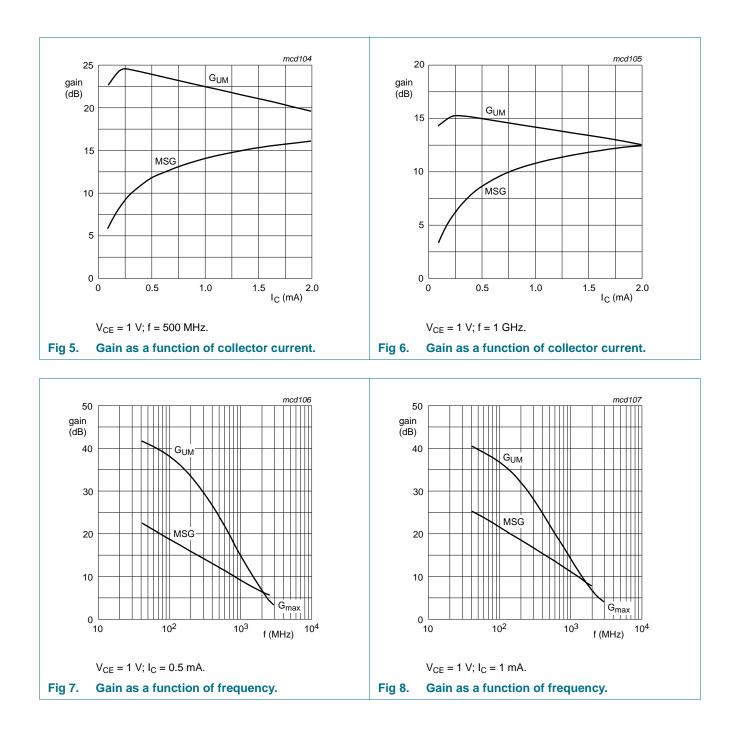


Figure 5, 6, 7 and 8,  $G_{UM}$  = maximum unilateral power gain; MSG = maximum stable gain.

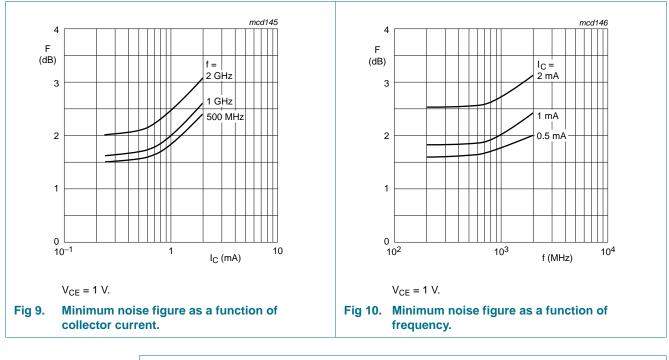
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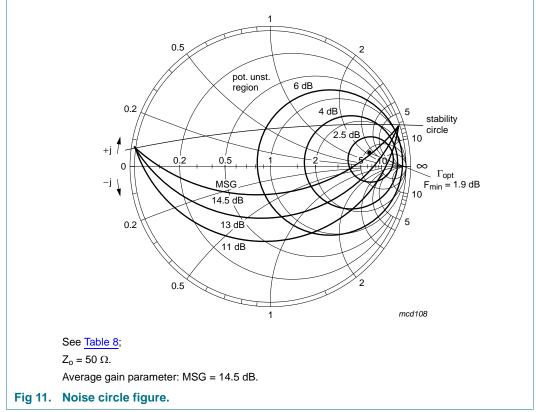
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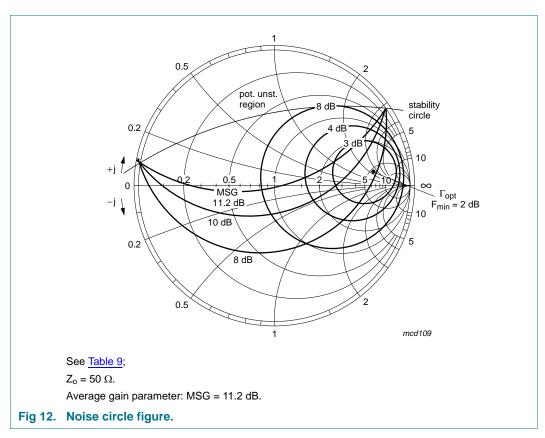




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Table 8.	Noise param	eters				
f (MHz)	V <sub>CE</sub> (V)	V <sub>CE</sub> (V) I <sub>C</sub> (mA)	F <sub>min</sub> (dB)	Γ <sub>opt</sub>	Γ <sub>opt</sub>	
				(mag)	(ang)	
500	1	1	1.9	0.79	4	2.5



#### Table 9. Noise parameters

f (MHz)	V <sub>CE</sub> (V)	l <sub>C</sub> (mA)	F <sub>min</sub> (dB)	Γ <sub>opt</sub>		R <sub>n</sub> /50
				(mag)	(ang)	
1000	1	1	2	0.74	8	2.6

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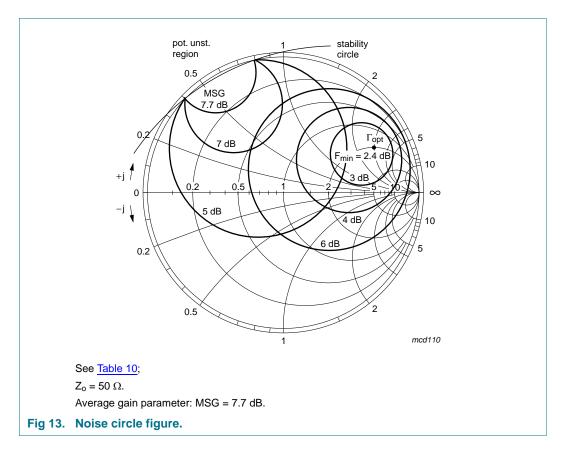
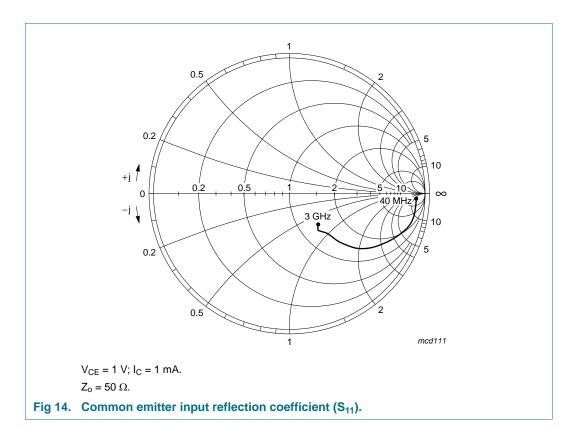
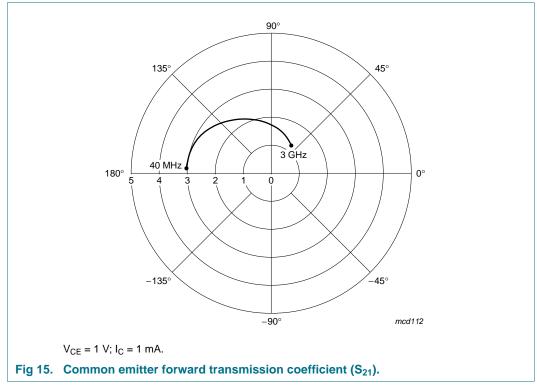


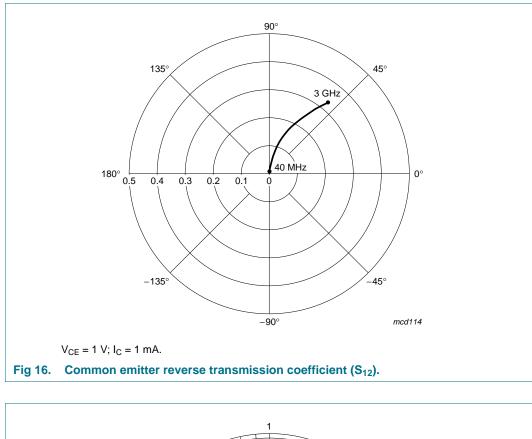
Table 10.Noise parameters

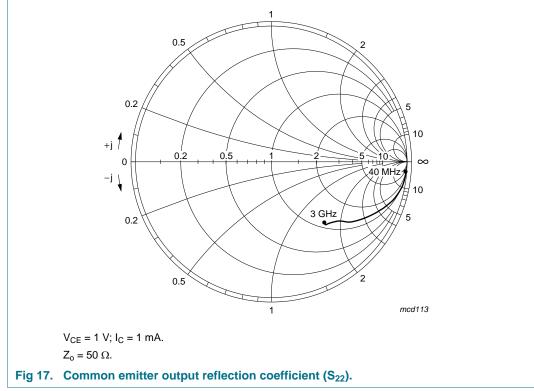
f (MHz)	V <sub>CE</sub> (V)	I <sub>C</sub> (mA)	F <sub>min</sub> (dB)	Γ <sub>opt</sub>		R <sub>n</sub> /50
				(mag)	(ang)	
2000	1	1	2.4	0.72	26	1.7





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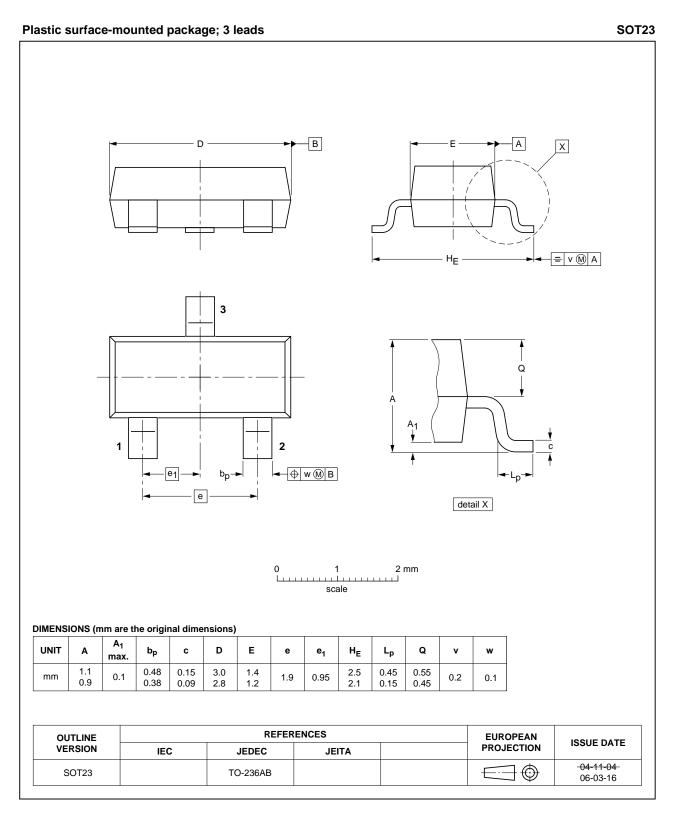




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# 8. Package outline



#### Fig 18. Package outline.

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# 9. Revision history

Table 11. Revision h	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BFT25A v.5	20110912	Product data sheet	-	BFT25A v.4
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	<ul> <li>Legal texts</li> </ul>	have been adapted to the r	new company name whe	ere appropriate.
	<ul> <li>Package o</li> </ul>	utline drawings have been u	pdated to the latest vers	sion.
BFT25A v.4 (9397 750 13399)	20040706	Product data sheet	-	BFT25A_CNV v.3
BFT25A_CNV v.3	19971205	Product specification	-	-

# **10. Legal information**

## **10.1 Data sheet status**

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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